WINSTAR Display

OLED SPECIFICATION

Model No:

WEO012864BLPP3N00000

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OLED Specification

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WINSTAR Display

華凌光電股份有限公司

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Technology - Innovation - Value

Eco Friendly - Revolution

WIN YOUR LIFE, STAR YOUR EYES

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SPECIFICATION Ver:0

CUSTOMER :

MODULE NO.: WEO012864BLPP3N00000

APPROVED BY:		
(FOR CUSTOMER USE ONLY)		
	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
ISSUED DATE:			

MODLE							
RECO	ORDS OF REVISIO	DN	DOC. FIRST ISSUE				
VERSION		REVISED PAGE NO.	SUMMARY				
0	2012/09/17		First issue				

1. Module Classification Information

$\frac{W}{4} \underset{2}{\overset{E}{_{3}}} \underbrace{O}_{4} \underbrace{O12864}_{5} \underset{6}{\overset{E}{_{5}}} \underbrace{B}_{6} \underset{8}{\overset{E}{_{9}}} \underbrace{P}_{10} \underset{0}{\overset{3}{_{10}}} \underbrace{O0000}_{0}$

1Brand : WINSTAR DISPLAY CORPORATION2E : OLED3Display Type : H \rightarrow Character Type, G \rightarrow Graphic Type, O \rightarrow COG Type4Number of dots : 128*64 Dots5Serials code6Emitting Color6A : Amber8B : Blue7Polarizer9Driver Voltage33: 3.0 V; 5: 5.0V10Touch Panel11Products type11Products type	U L						
3 Display Type : H→Character Type, G→Graphic Type, O→COG Type 4 Number of dots : 128*64 Dots 5 Serials code 6	1	Brand : WINSTA	R DISPLAY CORPORATION				
4 Number of dots : 128*64 Dots 5 Serials code 6 Emitting Color A : Amber R : RED B : Blue C : Full color G : Green W : White Y : Yellow Green L : Yellow 7 Polarizer P : With Polarizer; N: Without Polarizer 8 Display Mode P : Passive Matrix ; A: Active Matrix 9 Driver Voltage 3: 3.0 V; 5: 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard type 1. Sunlight Readable type	2	E : OLED	E : OLED				
5 Serials code 6 Emitting Color B : Blue C : Full color G : Green W : White Y : Yellow Green L : Yellow 7 Polarizer P : With Polarizer; N: Without Polarizer 8 Display Mode P : Passive Matrix ; A: Active Matrix 9 Driver Voltage 3: 3.0 V; 5: 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard type 1. Sunlight Readable type	3	Display Type : H	play Type : H \rightarrow Character Type, G \rightarrow Graphic Type, O \rightarrow COG Type				
A : AmberR : RED6Emitting ColorB : BlueC : Full colorG : GreenW : WhiteY : Yellow GreenL : Yellow7PolarizerP : With Polarizer; N: Without Polarizer8Display ModeP : Passive Matrix ; A: Active Matrix9Driver Voltage3: 3.0 V; 5: 5.0V10Touch PanelN : Without touch panel; T: With touch panel0 : Standard type1. Sunlight Readable type	4	Number of dots :	128*64 Dots				
B : BlueC : Full colorG : GreenW : WhiteY : Yellow GreenL : YellowV : PolarizerP : With Polarizer; N: Without PolarizerB Display ModeP : Passive Matrix ; A: Active MatrixP Driver Voltage3: 3.0 V; 5: 5.0VN : Without touch panel; T: With touch panel0 : Standard type1. Sunlight Readable type	5	Serials code					
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8 Display Mode P : Passive Matrix ; A: Active Matrix 9 Driver Voltage 3: 3.0 V; 5: 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard type 1. Sunlight Readable type			Y: Yellow Green	L : Yellow			
9 Driver Voltage 3: 3.0 V; 5: 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard type 1. Sunlight Readable type	7	Polarizer	P: With Polarizer; N: Withou	t Polarizer			
10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard type 1. Sunlight Readable type	8	Display Mode	P : Passive Matrix ; A: Active Matrix				
0 : Standard type 1. Sunlight Readable type	9	Driver Voltage	3: 3.0 V; 5: 5.0V				
1. Sunlight Readable type	10	Touch Panel	N : Without touch panel; T: With touch panel				
17 Transparent OLED (TOLED) 3. Flexible OLED 4. OLED for Lighting	11	Products type	 Sunlight Readable type Transparent OLED (TOLE Flexible OLED 	ED)			
12 Product grades 0 : Standard(A-level) 12 Product grades 2 : B-level 3 : C-level 3 : C-level 4 : high class(AA-level) 5 : Customer offerings	12	Product grades	 0 : Standard(A-level) 2 : B-level 3 : C-level 4 : high class(AA-level) 				
13 Serial No. Application serial number(00~ZZ)	13	Serial No.	Application serial number(00~ZZ	Ζ)			

2. General Description

ltem	Dimension Un	
Number of Characters	128 x 64 Dots	_
Module dimension	45.24 × 29.14 × 2.05 (mm)	mm
Active Area	35.056 × 17.52 (mm)	mm
Pixel Pitch	0.274 × 0.274 (mm)	mm
Pixel Size	0.258 × 0.258 (mm)	mm
Display Mode	Passive Matrix	L
Display Color	Yellow	
Drive Duty	1/64 Duty	

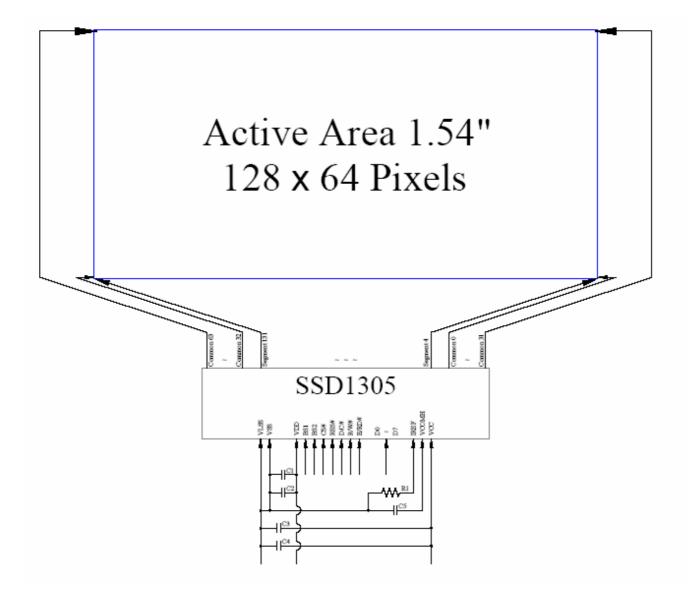
3. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1,2
Supply Voltage for Display	VCC	0	15	V	1,2
Operating Temperature	TOP	-40	80	Ĵ	-
Storage Temperature	TSTG	-40	80	Ĵ	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3."Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

4. Block Diagram

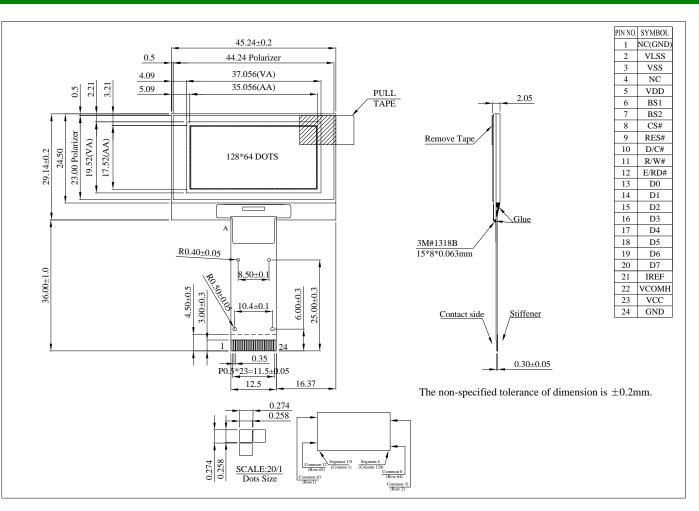


MCU Interface Selection: BS1 and BS2

Pins connected to MCU interface: CS#, RES#, D/C#, R/W#, E/RD#, and D0~D7 C1, C3: $0.1 \mu F$

- C2: 4.7µF
- C4: 10µF
- C5: 4.7µF / 25V Tantalum Capacitor
- R1: $910k\Omega$, R1 = (Voltage at IREF VSS) / IREF

5. Contour Drawing



6. Interface Pin Function

No.	Symbol	Function					
		Reserved Pin					
1	NC(GND)	The supportin	g pins can rec	luce the influe	nces from str	esses on the	
		function pins.	These pins m	ust be connec	ted to externa	l ground.	
		Ground of An	alog Circuit				
2	VLSS	This is an ana	log ground pi	n. It should be	connected to	VSS	
		externally.					
		Ground of Lo	gic Circuit				
3	VSS	This is a grou	nd pin. It also	acts as a refer	rence for the l	ogic pins. It	
		must be conne	ected to extern	nal ground.			
		Reserved Pin					
4	NC	The N.C. pins between function pins are reserved for compatible					
		and flexible design.					
5	VDD	Power Supply					
5	, DD				onnected to ex	ternal source.	
			ng Protocol S				
6	BS1	-	re MCU inter	face selection	input. See the	e following	
0	DOT	table:					
			68XX-parallel	80XX-parallel	Serial	I2C	
7	BS2	BS1	0	1	0	1	
,	0.02	BS2	1	1	0	0	
		Chip Select					
8	CS#	This pin is the chip select input. The chip is enabled for					
		MCU commu			pulled low		
		Power Reset f					
9	RES#	-		ut. When the	pin is low, ini	tialization of	
		the chip is exe					
		Data/Comma					
		-		d control pin.	-	-	
		high, the inpu					
		pulled low, th					
10	D/C#	register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams.					
		When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at					
		SDIN will be transferred to the command register. In I2C mode, this					
		pin acts as SA				2C mode, uns	
		Read/Write Se		uless selectio			
				nput. When ir	terfacing to a	68XX-series	
		-		1	0		
		microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it					
11	R/W#	"Low" for wr	-	i i ingli i i	i cua mode u	Puil It to	
				e is selected, t	his pin will be	e the Write	
				eration is initi	-		
		· · •	-			r	
		pulled low and	-			-	

12	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
13~20	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
21	IREF	<i>Current Reference for Brightness Adjustment</i> This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10µA.
22	VCOMH	<i>Voltage Output High Level for COM Signal</i> This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
23	VCC	<i>Power Supply for OEL Panel</i> This is the most positive voltage supply pin of the chip. It must be supplied externally.
24	GND	<i>Reserved Pin (Supporting Pin)</i> The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

7. Optics & Electrical Characteristics

7.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness	Lbr	With Polarizer (Note 3)	100	-	-	cd/m2
C.I.E. (Yellow)	(x) (y)	Without Polarizer	0.43	0.47	0.51	
			0.46	0.50	0.54	
Dark Room Contrast	CR		-	>2000:1	-	
View Angle			>160	-	-	degree

* Optical measurement taken at $V_{DD} = 2.8V$, $V_{CC} = 12.5V$. Software configuration follows Section 4.4 Initialization.

7.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	Vdd		2.4	2.8	3.5	V
Supply Voltage for Display	Vcc	Note 3	14.5	15.0	15.5	V
High Level Input	Vін	Ιουτ= 100μΑ, 3.3MHz	0.8×Vdd	-	Vdd	V
Low Level Input	VIL	Ιουτ= 100μΑ, 3.3MHz	0	-	0.2×Vdd	V
High Level Output	Vон	Ιουτ= 100μΑ, 3.3MHz	0.9×Vdd	-	Vdd	V
Low Level Output	Vol	Ιουτ= 100μΑ, 3.3MHz	0	-	0.1×Vdd	V
Operating Current for VDD	ldd	Note 4 Note 5		180 180	300 300	μΑ μΑ
Operating Current for Vcc	lcc	Note 4 Note 5		60 72	100 120	mA mA
Sleep Mode Current for VDD	Idd, Sleep		-	1	5	μA
Sleep Mode Current for Vcc	ICC, SLEEP		-	1	5	μA

Note 3: Brightness (L_{br}) and Supply Voltage for Display (Vcc) are subject to the change of the panel characteristics and the customer's request.

Note 4: $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 50% Display Area Turn on.

Note 5: $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 100% Display Area Turn on.

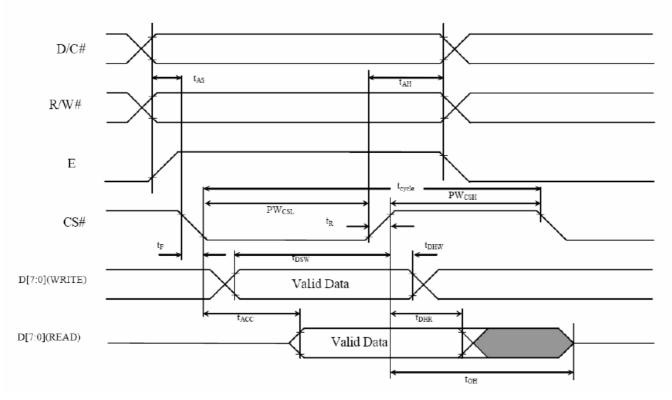
* Software configuration follows Section 4.4 Initialization.

7.3 AC Characteristics

7.3.1 68XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Мах	Unit
tcycle	System Cycle Time	300	-	ns
tas	Address Setup Time	0	-	ns
tан	Address Hold Time	0	-	ns
tosw	Write Data Setup Time	40	-	ns
t DHW	Write Data Hold Time	7	-	ns
t DHR	Read Data Hold Time	20	-	ns
tон	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
PWcsl	Chip Select Low Pulse Width (Read) Chip Select Low Pulse width (Write)	120 60	-	ns
РWcsн	Chip Select High Pulse Width (Read) Chip Select High Pulse Width (Write)	60 60	-	ns
t R	Rise Time	-	15	ns
tF	Fall Time	-	15	ns

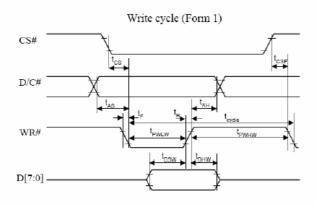
* (VDD - VSS = 2.4V to 3.5V, Ta = 25°C)

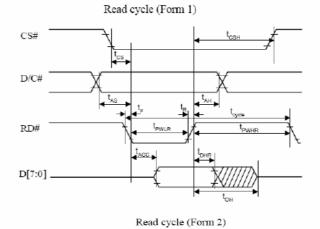


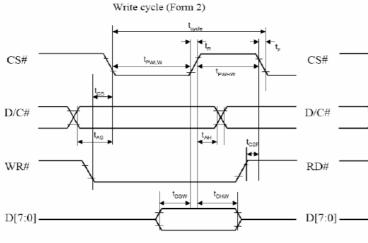
7.3.2 80XX-Series MPU Parallel Interface Timing Characteristics:

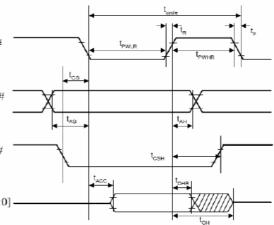
Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	300	-	ns
tas	Address Setup Time	10	-	ns
tан	Address Hold Time	0	-	ns
tosw	Write Data Setup Time	40	-	ns
t DHW	Write Data Hold Time	7	-	ns
t DHR	Read Data Hold Time	20	-	ns
tон	Output Disable Time	-	70	ns
tacc	Access Time	-	140	ns
t PWLR	Read Low Time	120	-	ns
t PWLW	Write Low Time	60	-	ns
t PWHR	Read High Time	60	-	ns
t PWHW	Write High Time	60	-	ns
tcs	Chip Select Setup Time	0	-	ns
tсsн	Chip Select Hold Time to Read Signal	0	-	ns
tcsF	Chip Select Hold Time	20	-	ns
tR	Rise Time	-	15	ns
t⊧	Fall Time	-	15	ns

* (VDD - VSS = 2.4V to 3.5V, $T_a = 25^{\circ}$ C)







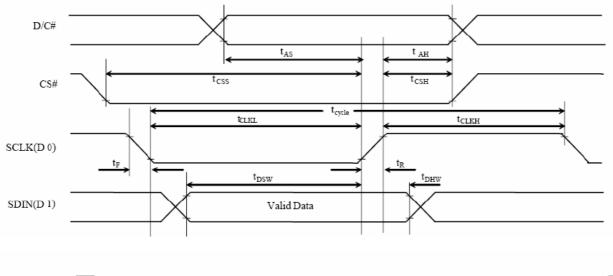


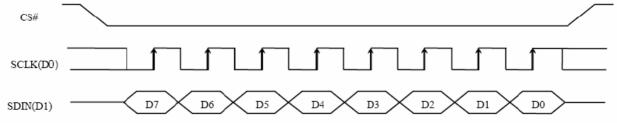
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7.3.3 Serial Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t cycle	Clock Cycle Time	250	-	ns
tas	Address Setup Time	150	-	ns
tан	Address Hold Time	150	-	ns
tcss	Chip Select Setup Time	120	-	ns
tcsн	Chip Select Hold Time	60	-	ns
tosw	Write Data Setup Time	50	-	ns
t DHW	Write Data Hold Time	15	-	ns
t CLKL	Serial Clock Low Time	100	-	ns
t CLKH	Serial Clock High Time	100	-	ns
tr	Rise Time	-	15	ns
t⊧	Fall Time	-	15	ns

* (V_{DD} - V_{SS} = 2.4V to 3.5V, $T_a = 25^{\circ}C$)

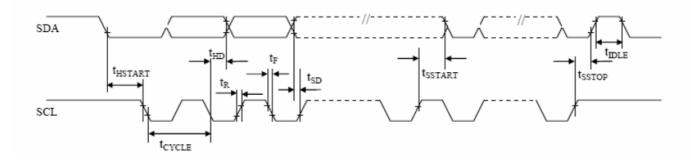




7.3.4 I₂C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	2.5	-	us
t HSTART	Start Condition Hold Time	0.6	-	us
tнр	Data Hold Time (for "SDAou⊤" Pin) Data Hold Time (for "SDAıℕ" Pin)	0 300	-	ns
tsp	Data Setup Time	100	-	ns
	Start Condition Setup Time			
t sstart	(Only relevant for a repeated Start condition)	0.6	-	us
t SSTOP	Stop Condition Setup Time	0.6	-	us
tr	Rise Time for Data and Clock Pin		300	ns
tF	Fall Time for Data and Clock Pin		300	ns
tidle	Idle Time before a New Transmission can Start	1.3	-	US

* (V_{DD} - V_{SS} = 2.4V to 3.5V, T_a = 25°C)



8. Reliability

8.1 Contents of Reliability Tests

ltem	Conditions	Criteria	
High Temperature Operation	80℃, 240 hrs		
Low Temperature Operation	-40℃, 240 hrs		
High Temperature Storage	80℃, 240 hrs		
Low Temperature Storage	-40℃, 240 hrs	The operational	
HighTemperature/Humidity Storage	60℃, 90% RH, 240 hrs	functions work.	
Thermal Shock	-40℃ ⇔80℃, 24 cycles 1 hr dwell		

* The samples used for the above tests do not include polarizer.

* No moisture condensation is observed during tests.

8.2 Lifetime

End of lifetime is specified as 50% of initial brightness reached.

Parameter	Min	Max	Unit	Condition	Notes
Operating Life	10,000	-	hr	100 cd/m ₂ ,50%Checkerboard	0
Time	40,000	-	hr	100 cd/m ₂ , 50% Checkerboard	6

Note 6: The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

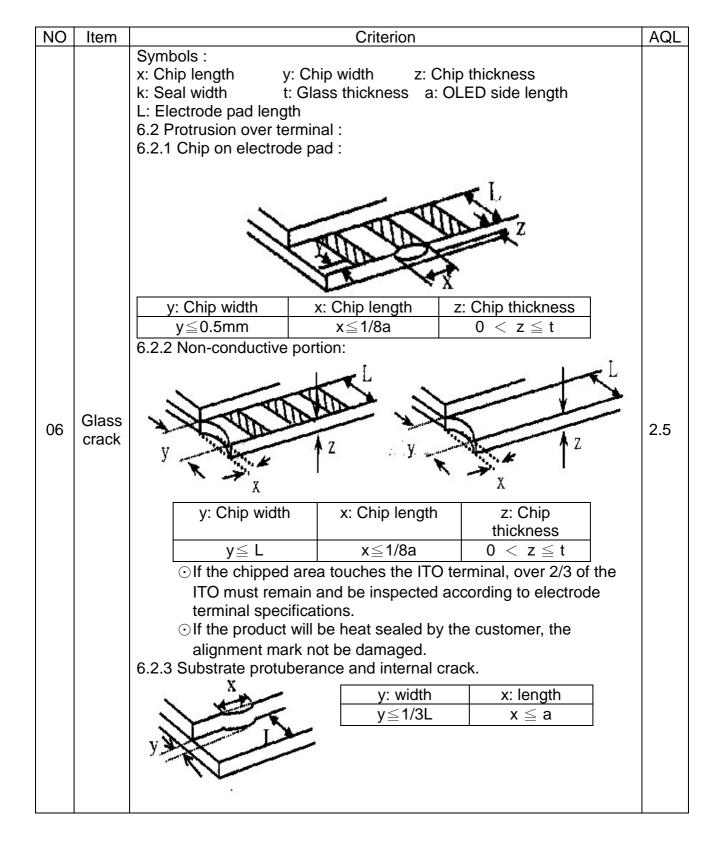
8.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23 ± 5 °C; 55 ± 15 % RH.

9. Inspection specification

NO	Item	Criterion				AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 				0.65
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			2.5	
OLED black spots, white spots, contaminatio		3.1 Round type Φ=(x + y) /		owing drawing		2.5
n	n (non-display) 3.2 Line type : (As follow Length L≦3.0 L≦2.5 	ving drawing) Width W≦0.02 0.02 <w≦0.03 0.03<w≦0.05 0.05<w< td=""><td>Acceptable Q TY Accept no dense 2 As round type</td><td>2.5</td></w<></w≦0.05 </w≦0.03 	Acceptable Q TY Accept no dense 2 As round type	2.5	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ Φ \leq 0.20 0.20<Φ \leq 0.50 0.50<Φ \leq 1.00 1.00<Φ	Acceptable Q TY Accept no dense 3 2 0 3 3	2.5

NO	Item	Criterion			
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
		Symbols Define: x: Chip length y k: Seal width t L: Electrode pad length 6.1 General glass chip 6.1.1 Chip on panel s x z: Chip thickness $Z \leq 1/2t$ $1/2t < z \leq 2t$	ack spots, white spots r: Chip width z: C : Glass thickness a: th: p :	hip thickness OLED side length reen panels: $x \in Chip length$ $x \le 1/8a$ $x \le 1/8a$	AQL 2.5
		z: Chip thickness Z≦1/2t	y: Chip width Not over viewing	x: Chip length x≦1/8a	
		1/2t <z≦2t< td=""><td>area Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	area Not exceed 1/3k	x≦1/8a	
			re chips, x is the total	length of each chip.	



NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	
10	PCB \ COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	 2.5 2.5 2.5 0.65 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Flicker	Major	Not Allowable
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	